

Programmable Timing Control Hub™ for P4™ processor

Recommended Application:

SIS 645/650 style chipsets.

Output Features:

- 2 Pairs of differential CPUCLKs (differential current mode)
- 1 SDRAM @ 3.3V
- 8 PCI @3.3V
- 2 AGP @ 3.3V
- 2 ZCLKs @ 3.3V
- 1- 48MHz, @3.3V fixed.
- 1- 24/48MHz, @3.3V selectable by I²C (Default is 24MHz)
- 3- REF @3.3V, 14.318MHz.

Features/Benefits:

- Selectable asynchronous/synchronous AGP, ZCLK and PCI outputs
- Programmable output frequency, divider ratios, output rise/ falltime, output skew.
- Programmable spread percentage for EMI control.
- Watchdog timer technology to reset system if system malfunctions.
- Programmable watch dog safe frequency.
- Support I²C Index read/write and block read/write operations.
- For PC133 SDRAM system use the ICS9179-16 as the memory buffer.
- For DDR SDRAM system use the ICS93705 or ICS93722 as the memory buffer.
- Uses external 14.318MHz crystal.

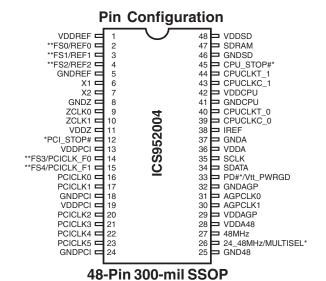
Key Specifications:

- PCI PCI output skew: < 500ps
- CPU SDRAM output skew: < 1ns
- AGP AGP output skew: <150ps

Functionality

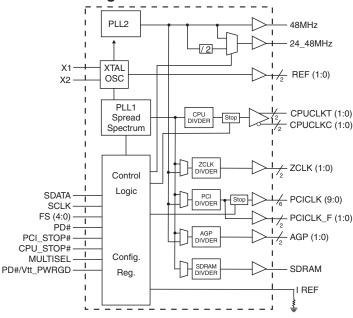
Bit 2	Bit 7	Bit 6	Bit 5	Bit 4	CPU	SDRAM	ZCLK	AGP	PCI
FS4	FS3	FS2	FS1	FS0	(MHz)	(MHz)	(MHz)	(MHz)	(MHz)
0	0	0	0	0	66.67	66.67	66.67	66.67	33.33
0	0	0	0	1	100.00	100.00	66.67	66.67	33.33
0	0	0	1	0	100.00	200.00	66.67	66.67	33.33
0	0	0	1	1	100.00	133.33	66.67	66.67	33.33
0	0	1	0	0	100.00	150.00	60.00	60.00	30.00
0	0	1	0	1	100.00	125.00	62.50	62.50	31.25
0	0	1	1	0	100.00	160.00	66.67	66.67	33.33
0	0	1	1	1	100.00	133.33	80.00	66.67	33.33
0	1	0	0	0	100.00	200.00	66.67	66.67	33.33
0	1	0	0	1	100.00	166.67	62.50	62.50	31.25
0	1	0	1	0	100.00	166.67	71.43	83.33	41.67
0	1	0	1	1	80.00	133.33	66.67	66.67	33.33
0	1	1	0	0	80.00	133.33	66.67	66.67	33.33
0	1	1	0	1	95.00	95.00	63.33	63.33	31.67
0	1	1	1	0	95.00	126.67	63.33	63.33	31.67
0	1	1	1	1	66.67	66.67	50.00	50.00	25.00

Note: For additional margin testing frequencies, refer to Byte 4



- * These inputs have a 120K pull up to VDD.
- * These inputs have a 120K pull down to GND.

Block Diagram



Power Groups

VDDCPU = CPU VDDPCI = PCICLK_F, PCICLK VDDSD = SDRAM AVDD48 = 48MHz, 24MHz, fixed PLL AVDD = Analog Core PLL VDDAGP= AGP VDDREF = Xtal, REF VDDZ = ZCLK



General Description

The ICS952004 is a two chip clock solution for desktop designs using SIS 645/650 style chipsets. When used with a zero delay buffer such as the ICS9179-06 for PC133 or the ICS93705 for DDR applications it provides all the necessary clocks signals for such a system.

The ICS952004 is part of a whole new line of ICS clock generators and buffers called TCH™ (Timing Control Hub). ICS is the first to introduce a whole product line which offers full programmability and flexibility on a single clock device. Employing the use of a serially programmable I²C interface, this device can adjust the output clocks by configuring the frequency setting, the output divider ratios, selecting the ideal spread percentage, the output skew, the output strength, and enabling/disabling each individual output clock. TCH also incorporates ICS's Watchdog Timer technology and a reset feature to provide a safe setting under unstable system conditions. M/N control can configure output frequency with resolution up to 0.1MHz increment.

Pin Description

PIN NUMBER	PIN NAME	TYPE	DESCRIPTION	
1, 11, 13, 19, 29, 42, 48	VDD	PWR	Power supply for 3.3V	
2	FS0	IN	Frequency select pin.	
2	REF0	OUT	14.318 MHz reference clock.	
3	FS1	IN	Frequency select pin.	
3	REF1	OUT	14.318 MHz reference clock.	
4	FS2	IN	Frequency select pin.	
4	REF2	OUT	14.318 MHz reference clock.	
5, 8, 18, 24, 25, 32, 37, 41, 46	GND	PWR	Ground pin for 3V outputs.	
6	X1	IN	Crystal input,nominally 14.318MHz.	
7	X2	OUT	Crystal output, nominally 14.318MHz.	
10, 9	ZCLK(1:0)	OUT	Hyperzip clock outputs.	
12	PCI_STOP#	IN	Stops all PCICLKs besides the PCICLK_F clocks at logic 0 level, when MODE pin is in Mobile mode	
14	FS3	IN	Frequency select pin.	
14	PCICLK_F0	OUT	PCI clock output, not affected by PCI_STOP#	
15	FS4	IN	Frequency select pin.	
15	PCICLK_F1	OUT	PCI clock output, not affected by PCI_STOP#	
23, 22, 21, 20, 17, 16	PCICLK (5:0)	OUT	PCI clock outputs.	
26	MULTISEL	IN	3.3V LVTTL input for selecting the current multiplier for CPU outputs.	
20	24_48MHz	OUT	Clock output for super I/O/USB default is 24MHz	
27	48MHz	OUT	48MHz output clock	
28, 36	AVDD	PWR	Analog power supply 3.3V	
30, 31	AGPCLK (1:0)	OUT	AGP outputs defined as 2X PCI. These may not be stopped.	
33	PD#	IN	Asynchronous active low input pin used to power down the device into a low power state. The internal clocks are disabled and the VCO and the crystal are stopped. The latency of the power down will not be greater than 3ms.	
33	Vtt_PWRGD	IN	This pin acts as a dual function input pin for Vtt_PWRGD and PD# signal. When Vtt_PWRGD goes high the frequency select will be latched at power on thereafter the pin is an asynchronous active low power down pin.	
34	SDATA	I/O	Data pin for I ² C circuitry 5V tolerant	
35	SCLK	IN	Clock pin of I ² C circuitry 5V tolerant	
38	l REF	OUT	This pin establishes the reference current for the CPUCLK pairs. This pin requires a fixed precision resistor tied to ground in order to establish the appropriate current.	
43, 39	CPUCLKC (1:0)	OUT	"Complementary" clocks of differential pair CPU outputs. These clocks	
44, 40	CPUCLKT (1:0)	OUT	"True" clocks of differential pair CPU outputs. These clocks are in phase with SDRAM clocks. These open drain outputs need an external 1.5V jup.	
45	CPU_STOP#	IN	Stops all CPUCLKs clocks at logic 0 level, when MODE pin is in Mobile mode	
47	SDRAM	OUT	SDRAM clock output.	

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CPUCLK Swing Select Functions

			D.C. D		
MULTSEL0	Byte 23 Bit 7	Board Target Trace/Term Z	Reference R, Iref= Vdd/(3*Rr)	Output Current	Voh @ Z, Iref=2.32mA
0	0	60 ohms	$Rr = 475 \ 1\%$ Iref = 2.32mA	Ioh = 5*Iref	0.71V @ 60
0	0	50 ohms	Rr = 475 1% Iref = 2.32mA	Ioh = 5*Iref	0.59V @ 50
0	1	60 ohms	Rr = 475 1% Iref = 2.32mA	Ioh = 4*Iref	0.56V @ 60
0	1	50 ohms	Rr = 475 1% Iref = 2.32mA	Ioh = 4*Iref	0.47V @ 50
1	0	60 ohms	Rr = 475 1% Iref = 2.32mA	Ioh = 6*Iref	0.85V /2 60
1	0	50 ohms	Rr = 475 1% Iref = 2.32mA	Ioh = 6*Iref	0.71V @ 50
1	1	60 ohms	Rr = 475 1% Iref = 2.32mA	Ioh = 7*Iref	0.99V @ 60
1	1	50 ohms	Rr = 475 1% Iref = 2.32mA	Ioh = 7*Iref	0.82V @ 50
0	0	30 (DC equiv)	Rr = 221 1% Iref = 5mA	Ioh = 5*Iref	0.75V @ 30
0	0	25 (DC equiv)	Rr = 221 1% Iref = 5mA	Ioh = 5*Iref	0.62V @ 20
0	1	30 (DC equiv)	Rr = 221 1% Iref = 5mA	Ioh = 4*Iref	0.60 @ 20
0	1	25 (DC equiv)	Rr = 221 1% Iref = 5mA	Ioh = 4*Iref	0.5V @ 20
1	0	30 (DC equiv)	Rr = 221 1% Iref = 5mA	Ioh = 6*Iref	0.90V @ 30
1	0	25 (DC equiv)	Rr = 221 1% Iref = 5mA	Ioh = 6*Iref	0.75V @ 20
1	1	30 (DC equiv)	Rr = 221 1% Iref = 5mA	Ioh = 7*Iref	1.05V @ 30
1	1	25 (DC equiv)	Rr = 221 1% Iref = 5mA	Ioh = 7*Iref	0.84V @ 20



General I²C serial interface information for the ICS952004

How to Write:

- · Controller (host) sends a start bit.
- Controller (host) sends the write address D2 (H)
- ICS clock will acknowledge
- Controller (host) sends the begining byte location = N
- ICS clock will acknowledge
- Controller (host) sends the data byte count = X
- ICS clock will acknowledge
- Controller (host) starts sending Byte N through Byte N + X -1 (see Note 2)
- ICS clock will acknowledge each byte one at a time
- · Controller (host) sends a Stop bit

index block write Operation							
Coi	ntroller (Host)	ICS (Slave/Receiver)					
Т	starT bit						
Slav	e Address D2 _(H)						
WR	WRite						
			ACK				
Beg	inning Byte = N						
			ACK				
Data	Byte Count = X						
			ACK				
Begir	nning Byte N						
			ACK				
	0	te l					
	0	X Byte	0				
	0	\times	0				
		0					
Byte	e N + X - 1						
		ACK					
Р	stoP bit						

Index Block Write Operation

How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the write address D2 (H)
- ICS clock will acknowledge
- Controller (host) sends the begining byte location = N
- ICS clock will acknowledge
- Controller (host) will send a separate start bit.
- Controller (host) sends the read address D3_(H)
- ICS clock will acknowledge
- ICS clock will send the data byte count = X
- ICS clock sends Byte N + X -1
- ICS clock sends Byte 0 through byte X (if X_(H) was written to byte 8).
- · Controller (host) will need to acknowledge each byte
- Controllor (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

Index Block Read Operation							
Cor	troller (Host)	IC	S (Slave/Receiver)				
Т	starT bit						
Slave	e Address D2 _(H)						
WR	WRite						
			ACK				
Begi	nning Byte = N						
			ACK				
RT	Repeat starT						
Slave	e Address D3 _(H)						
RD	ReaD						
		ACK					
		Data Byte Count = X					
	ACK						
			Beginning Byte N				
	ACK						
		X Byte	0				
	0	<u> </u>	0				
	0	×	0				
	0						
	Ī		Byte N + X - 1				
N	Not acknowledge						
Р	stoP bit						

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^{*}See notes on the following page.



Serial Configuration Command Bitmap

Bytes 0-3: Are reserved for external clock buffer.

Byte4: Functionality and Frequency Select Register (default = 0)

Bit							Des	cription				PWD	
	Bit 2	Bit 7	Bit 6	Bit 5	Bit 4								
	FS4	FS3	FS2	FS1	FS0	CPU	SDRAM	ZCLK	AGP	PCI	Spread Precentage	1	
	0	0	0	0	0	66.67	66.67	66.67	66.67	33.33	0 to -0.5% Down Spread	1	
	0	0	0	0	1	100.00	100.00	66.67	66.67	33.33	0 to -0.5% Down Spread	1	
	0	0	0	1	0	100.00	200.00	66.67	66.67	33.33	0 to -0.5% Down Spread	1	
	0	0	0	1	1	100.00	133.33	66.67	66.67	33.33	0 to -0.5% Down Spread	1	
	0	0	1	0	0				(Reser	ved)	•	1	
	0	0	1	0	1				(Reser	ved)		1	
	0	0	1	1	0	100.00	160.00	66.67	66.67	33.33	+/- 0.25% Center Spread	1	
	0	0	1	1	1	100.00	133.33	80.00	66.67	33.33	0 to -0.5% Down Spread	1	
	0	1	0	0	0	100.00	200.00	66.67	66.67	33.33	+/- 0.25% Center Spread	1	
	0	1	0	0	1	100.00	166.67	62.50	62.50	31.25	0 to -0.5% Down Spread	1	
	0	1	0	1	0	100.00	166.67	71.43	83.33	41.67	+/- 0.25% Center Spread	1	
	0	1	0	1	1				(Reser	ved)		1	
	0	1	1	0	0				(Reser	ved)		1	
	0	1	1	0	1	95.00	95.00	63.33	63.33	31.67	+/- 0.25% Center Spread	00000	
Bit 2	0	1	1	1	0	95.00	126.67	63.33	63.33	31.67	+/- 0.25% Center Spread	Note	
Bit 7:4	0	1	1	1	1		(Reserved)						
	1	0	0	0	0	105.00	140.00	70.00	70.00	35.00	+/- 0.25% Center Spread	1	
	1	0	0	0	1	100.90	100.90	67.27	67.27	33.63	+/- 0.25% Center Spread	1	
	1	0	0	1	0	108.00	144.00	72.00	72.00	36.00	+/- 0.25% Center Spread	1	
	1	0	0	1	1	100.90	134.53	67.27	67.27	33.63	+/- 0.25% Center Spread	1	
	1	0	1	0	0	112.00	149.33	74.67	74.67	37.33	+/- 0.25% Center Spread	1	
	1	0	1	0	1	133.33	100.00	66.67	66.67	33.33	0 to -0.5% Down Spread	1	
	1	0	1	1	0	133.33	133.33	66.67	66.67	33.33	+/- 0.25% Center Spread	1	
	1	0	1	1	1	133.33	166.67	66.67	66.67	33.33	+/- 0.25% Center Spread	1	
	1	1	0	0	0	100.00	133.00	80.00	66.67	33.33	+/- 0.25% Center Spread	1	
	1	1	0	0	1	100.00	100.00	80.00	66.67	33.33	+/- 0.25% Center Spread	1	
	1	1	0	1	0	100.00	166.67	83.33	62.50	31.25	+/- 0.25% Center Spread	1	
	1	1	0	1	1			'	(Reser	ved)		1	
	1	1	1	0	0	100.00	133.00	100.00	66.67	33.33	+/- 0.25% Center Spread	1	
	1	1	1	0	1	100.00	100.00	100.00	66.67	33.33	+/- 0.25% Center Spread	1	
	1	1	1	1	0	100.00	166.67	100.00	62.50	31.25	+/- 0.25% Center Spread	1	
	1	1	1	1	1			'	(Reser	ved)		1	
Bit 3	0 - Fre 1 - Fre	quency	is sele	cted by	hardwai Bit , 2 7	re select, L :4	atched Inpu	ts		·		0	
Bit 1		read Sp	ectrum	Enable	d							0	
Bit 0	0 - Ru 1- Trist		outputs	_								0	

Note1:

Default at power-up will be for latched logic inputs to define frequency, as displayed by Bit 3.

Note: PWD = Power-Up Default



Byte 5: Control Register (1 = enable, 0 = disable)

Bit	Pin#	PWD	Description				
Bit 7	30	1	AGPCLK1				
Bit 6	31	1	AGPCLK1				
Bit 5	26	0	SEL24_48MHz (0=24MHz, 1=48MHz)				
Bit 4	15	Х	FS4 Read Back				
Bit 3	14	X	FS3 Read Back				
Bit 2	4	Х	FS2 Read Back				
Bit 1	3	Х	FS1 Read Back				
Bit 0	2	X	FS0 Read Back				

Byte 6: Output Control Register (1 = enable, 0 = disable)

Bit	Pin#	PWD	Description
Bit 7	10	1	ZCLK1
Bit 6	9	1	ZCLK0
Bit 5	14	0	PCICLK_F0 stop control 0 = Free Running; 1 = Stop
Bit 4	15	0	PCICLK_F1 stop control 0 = Free Running; 1 = Stop
Bit 3	40, 39	1	CPUCLKT/C0 stop control 0 = Free Running; 1 = Stop
Bit 2	44, 43	1	CPUCLKT/C1 stop control 0 = Free Running; 1 = Stop
Bit 1	39, 40	1	CPUCLKT/C0 output control
Bit 0	43, 44	1	CPUCLKT/C1 output control

Byte 7: Output Control Register (1 = enable, 0 = disable)

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Bit	Pin#	PWD	Description				
Bit 7	15	1	PCICLK_F1				
Bit 6	14	1	PCICLK_F0				
Bit 5	23	1	PCICLK5				
Bit 4	22	1	PCICLK4				
Bit 3	21	1	PCICLK3				
Bit 2	20	1	PCICLK2				
Bit 1	17	1	PCICLK1				
Bit 0	16	1	PCICLK0				

Byte 8: Byte Count Read Back Register

Bit	Name	PWD	Description
Bit 7	Byte7	0	
Bit 6	Byte6	0	
Bit 5	Byte5	0	Note: Writing to this register will configure
Bit 4	Byte4	0	byte count and how many bytes will be
Bit 3	Byte3	1	read back, default is 0F _H = 15 bytes.
Bit 2	Byte2	1	
Bit 1	Byte1	1	
Bit 0	Byte0	1	

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Bit 0

Byte 9: Watchdog Timer Count Register

WD0

Bit	Name	PWD	Description
Bit 7	WD7	0	
Bit 6	WD6	0	The decimal representation of these 8 bits
Bit 5	WD5	0	correspond to X • 290ms the watchdog
Bit 4	WD4	1	timer will wait before it goes to alarm mode
Bit 3	WD3	0	and reset the frequency to the safe setting.
Bit 2	WD2	0	Default at power up is 16 • 290ms = 4.6
Bit 1	WD1	0	seconds.

Byte 10: Programming Enable bit 8 Watchdog Control Register

Bit	Name	PWD	Description
Bit 7	Program Enable	0	Programming Enable bit 0 = no programming. Frequencies are selected by HW latches or Byte0 1 = enable all I ² C programing.
Bit 6	WD Enable	0	Watchdog Enable bit
Bit 5	WD Alarm	0	Watchdog Alarm Status 0 = normal 1= alarm status
Bit 4	SF4	0	
Bit 3	SF3	0	Watchdog safe frequency bits. Writing to these bits
Bit 2	SF2	0	will configure the safe frequency corrsponding to
Bit 1	SF1	0	Byte 0 Bit 2, 7:4 table
Bit 0	SF0	1	

Byte 11: VCO Frequency M Divider (Reference divider) Control Register

Bit	Name	PWD	Description
Bit 7	Ndiv 8	Х	N divider bit 8
Bit 6	Mdiv 6	Х	
Bit 5	Mdiv 5	Х	
Bit 4	Mdiv 4	Х	The decimal respresentation of Mdiv (6:0)
Bit 3	Mdiv 3	Х	corresposd to the reference divider value. Default at power up is equal to the latched
Bit 2	Mdiv 2	Х	inputs selection.
Bit 1	Mdiv 1	Х	
Bit 0	Mdiv 0	Х	

Byte 12: VCO Frequency N Divider (VCO divider) Control Register

Bit	Name	PWD	Description
Bit 7	Ndiv 7	X	
Bit 6	Ndiv 6	X	The decimal representation of Ndiv (8:0)
Bit 5	Ndiv 5	Х	correspond to the VCO divider value.
Bit 4	Ndiv 4	Х	Default at power up is equal to the latched
Bit 3	Ndiv 3	Х	inputs selecton. Notice Ndiv 8 is located in
Bit 2	Ndiv 2	Х	Byte 11.
Bit 1	Ndiv 1	Х	
Bit 0	Ndiv 0	Х	



Byte 13: Spread Spectrum Control Register

Bit	Name	PWD	Description
Bit 7	SS 7	Х	T
Bit 6	SS 6	Х	The Spread Spectrum (12:0) bit will program the spread precentage. Spread
Bit 5	SS 5	Х	precent needs to be calculated based on
Bit 4	SS 4	Х	the VCO frequency, spreading profile,
Bit 3	SS 3	Х	spreading amount and spread frequency. It
Bit 2	SS 2	X	is recommended to use ICS software for
Bit 1	SS 1	Χ	spread programming. Default power on is latched FS divider.
Bit 0	SS 0	Х	idionod i o dividon

Byte 14: Spread Spectrum Control Register

Bit	Name	PWD	Description
Bit 7	Reserved	X	Reserved
Bit 6	Reserved	Х	Reserved
Bit 5	Reserved	Х	Reserved
Bit 4	SS 12	Х	Spread Spectrum Bit 12
Bit 3	SS 11	Х	Spread Spectrum Bit 11
Bit 2	SS 10	Х	Spread Spectrum Bit 10
Bit 1	SS 9	Х	Spread Spectrum Bit 9
Bit 0	SS 8	Х	Spread Spectrum Bit 8

Byte 15: Output Divider Control Register

Bit	Name	PWD	Description
Bit 7	SD Div 3	X	SDRAM clock divider ratio can be
Bit 6	SD Div 2	Х	configured via these 4 bits individually. For divider selection table refer to
Bit 5	SD Div 1	Х	Table 1. Default at power up is latched
Bit 4	SD Div 0	Х	FS divider.
Bit 3	CPU Div 3	Х	CPUCLKT/C clock divider ratio can be
Bit 2	CPU Div 2	Х	configured via these 4 bits individually. For divider selection table refer to
Bit 1	CPU Div 1	X	Table 1. Default at power up is latched
Bit 0	CPU Div 0	Х	FS divider.

Byte 16: Output Divider Control Register

Bit	Name	PWD	Description
Bit 7	AGP Div 3	X	AGP clock divider ratio can be
Bit 6	AGP Div 2	X	configured via these 4 bits individually. For divider selection
Bit 5	AGP Div 1	Х	table refer to Table 1. Default at
Bit 4	AGP Div 0	X	power up is latched FS divider.
Bit 3	ZCLK Div 3	X	ZCLK clock divider ratio can be
Bit 2	ZCLK Div 2	X	configured via these 4 bits individually. For divider selection
Bit 1	ZCLK Div 1	Х	table refer to Table 1. Default at
Bit 0	ZCLK Div 0	X	power up is latched FS divider.



Byte 17: Output Divider Control Register

Bit	Name	PWD	Description
Bit 7	AGP_INV	0	AGP Phase Inversion bit
Bit 6	ZCLK_INV	0	ZCLK Phase Inversion bit
Bit 5	SD_INV	0	SDRAM Phase Inversion bit
Bit 4	CPU_INV	0	CPUCLK Phase Inversion bit
Bit 3	PCI Div 3	Χ	PCI clock divider ratio can be
Bit 2	PCI Div 2	Х	configured via these 4 bits individually. For divider selection
Bit 1	PCI Div 1	Х	table refer to table 2. Default at
Bit 0	PCI Div 0	Χ	power up is latched FS divider.

Table 1 Table 2

Div (3:2)	00	01	10	4.4	Div (3:2)	00	01	10	4.4	
Div (1:0)	00	01	10	11	Div (1:0)	00	01	10		
00	/2	/4	/8	/16	00	/4	/8	/16	/32	
01	/3	/6	/12	/24	01	/3	/6	/12	/24	
10	/5	/10	/20	/40	10	/5	/10	/20	/40	
11	/7	/14	/28	/56	11	/7	/14	/28	/56	

Byte 18: Group Skew Control Register

Bit	Name	PWD	Description
Bit 7	CPU_Skew 1	1	These 2 bits delay the CPUCLKT/C (1:0)
Bit 6	CPU_Skew 0	1	clocks with respect to all other clocks. 00 = 0ps 01 = 250ps 10 = 500ps 11 = 750ps
Bit 5	SD_Skew 1	0	These 2 bits delay the SDRAM with respect to
Bit 4	SD_Skew 0	0	CPUCLK 00 = 0ps 01 = 250ps 10 = 500ps 11 =750ps
Bit 3	(Reserved)	Х	(Reserved)
Bit 2	(Reserved)	0	(Reserved)
Bit 1	(Reserved)	0	(Reserved)
Bit 0	Async 3V66	0	0 = 3V66 sync to CPUCLK 1 = 3V66 async to CPUCLK = 66.00 MHz



Byte 19: Group Skew Control Register

Bit	Name	PWD			Pr	og	rammab	le l	Del	ay	Sto	ор
Bit 7		1	0	0	0	0	1.85ns	1	0	0	0	3.05ns
Bit 6	These 4bits control	0	0	0	0	1	2.00ns	1	0	0	1	3.20ns
Bit 5	CPU-ZCLK(1:0)	0	0	0	1	0	2.15ns	1	0	1	0	3.35ns
Bit 4		0	0	0	1	1	2.30ns	1	0	1	1	3.50ns
Bit 3		1	0	1	0	0	2.45ns	1	1	0	0	3.65ns
Bit 2	These 4 bits control	0	0	1	0	1	2.60ns	1	1	0	1	3.80ns
Bit 1	CPU-AGP(1:0)	0	0	1	1	0	2.75ns	1	1	1	0	3.95ns
Bit 0		0	0	1	1	1	2.90ns	1	1	1	1	4.10ns

Byte 20: Group Skew Control Register

Bit	Name	PWD	PWD Programmable Delay Stop									ор
Bit 7		0	0	0	0	0	1.85ns	1	0	0	0	3.05ns
Bit 6	These 4bits control	1	0	0	0	1	2.00ns	1	0	0	1	3.20ns
Bit 5	CPU-PCICLK_F(1:0)	0	0	0	1	0	2.15ns	1	0	1	0	3.35ns
Bit 4		0	0	0	1	1	2.30ns	1	0	1	1	3.50ns
Bit 3		0	0	1	0	0	2.45ns	1	1	0	0	3.65ns
Bit 2	These 4 bits control	1	0	1	0	1	2.60ns	1	1	0	1	3.80ns
Bit 1	CPU-PCICLK(5:0)	0	0	1	1	0	2.75ns	1	1	1	0	3.95ns
Bit 0		0	0	1	1	1	2.90ns	1	1	1	1	4.10ns

Byte 21: Slew Rate Control Register

Bit	Name	PWD	Description
Bit 7	24/48 Slew	0	24/48 MHz clock slew rate control bits.
Bit 6	24/40_3IeW	0	01 = strong; 00, 11 = normal; 10 = weak
Bit 5	AGP Slew	0	AGP clock slew rate control bits.
Bit 4	AGP_Siew	0	01 = strong; 00, 11 = normal; 10 = weak
Bit 3	ZCLK Slew	0	ZCLK clock slew rate control bits.
Bit 2	ZCLN_Siew	0	01 = strong; 00, 11 = normal; 10 = weak
Bit 1	DEE Class	0	REF clock slew rate control bits.
Bit 0	REF_Slew	0	01 = strong; 00, 11 = normal; 10 = weak

Byte 22: Slew Rate Control Register

Bit	Name	PWD	Description
Bit 7	SDRAM Slew	0	SDRAM clock slew rate control bits.
Bit 6	SDITAINI SIEW	0	01 = strong; 00, 11 = normal;10 = weak
Bit 5	(Pagaryad)	X	(Pagaryad)
Bit 4	(Reserved)	Χ	(Reserved)
Bit 3	DOIOLK E Olam	0	PCICLK_F clock slew rate control bits.
Bit 2	PCICLK_F Slew	0	01 = strong; 00, 11 = normal; 10 = weak
Bit 1	PCICLK Slew	0	PCICLK clock slew rate control bits.
Bit 0	POICER Siew	0	01 = strong; 00, 11 = normal;10 = weak



Byte 23: Output Control Register

Bit	Pin#	PWD	Description
Bit 7	-	0	Iref Output Control
Bit 6	-	1	MULITSEL Readback
Bit 5	47	1	SDRAM
Bit 4	27	1	48MHz
Bit 3	26	1	24_48MHz
Bit 2	4	1	REF2
Bit 1	3	1	REF1
Bit 0	2	1	REF0



Absolute Maximum Ratings

Ambient Operating Temperature 0°C to +70°C Storage Temperature -65°C to +150°C

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Electrical Characteristics - Input/Supply/Common Output Parameters

 $T_A = 0 - 70C$; Supply Voltage $V_{DD} = 3.3 \text{ V} + /-5\%$

TA = 0 TOO, Cappiy Tollage	00					
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input High Voltage	V_{IH}		2		V _{DD} +0.3	V
Input Low Voltage	V_{IL}		V _{SS} -0.3		0.8	٧
Input High Current	I _{IH}	$V_{IN} = V_{DD}$	-5		5	mA
	I _{IL1}	V _{IN} = 0 V; Inputs with no pull-up resistors	-5			mA
Input Low Current	I _{IL2}	V _{IN} = 0 V; Inputs with pull-up resistors	-200			
Operating Supply Current	I _{DD3.3OP}	C _L = Full load		215	280	mA
Powerdown Current	I _{DD3.3PD}	IREF=2.32 mA		16	25	mA
Input Frequency	F_i	$V_{DD} = 3.3 \text{ V}$		14.318		MHz
Pin Inductance	L_{pin}				7	nΗ
	C_{IN}	Logic Inputs			5	pF
Input Capacitance ¹	C _{OUT}	Output pin capacitance			6	pF
	C_{INX}	X1 & X2 pins	27		45	pF
Clk Stabilization ^{1,2}	From Power! In or descention of			1.3	1.8	ms
CPU to SDRAM SKEW				0.4	1	ns
Delay ¹	t_{PZH}, t_{PZL}	Output enable delay (all outputs)	1		10	ns
	t_{PHZ}, t_{PLZ}	Output disable delay (all outputs)	1		10	ns

¹Guaranteed by design, not 100% tested in production.

²See timing diagrams for buffered and un-buffered timing requirements.



Electrical Characteristics - CPU (0.7V Select)

 $T_A = 0 - 70C$; $V_{DD} = 3.3V + /-5\%$; $C_L = 2pF$ (unless otherwise specified)

7. 7. 55	<u> </u>	oce officialities opeomed)	_	_		
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Current Source Output Impedance	Zo ¹	$V_O = V_x$	3000			Ω
Voltage High	VHigh	Statistical measurement on single	660	773	850	
Voltage Low	VLow	ended signal using oscilloscope math function.	-150	38	150	mV
Max Voltage	Vovs	Measurement on single ended		788	1150	m\/
Min Voltage	Vuds	signal using absolute value.	-450	-2		mV
Crossing Voltage (abs)	Vcross(abs)		250	342	550	mV
Crossing Voltage (var)	d-Vcross	Variation of crossing over all edges		28	140	mV
Rise Time	t _r	$V_{OL} = 0.175V, V_{OH} = 0.525V$	175	314	700	ps
Fall Time	t _f	$V_{OH} = 0.525 V V_{OL} = 0.175 V$	175	396	700	ps
Rise Time Variation	d-t _r			15	125	ps
Fall Time Variation	d-t _f			46	125	ps
Duty Cycle	d _{t3}	Measurement from differential wavefrom	45	51	55	%
Skew	t _{sk3}	$V_T = 50\%$		23	100	ps
Jitter, Cycle to cycle	t _{icvc-cvc} 1	V _T = 50%		57	150	ps

Electrical Characteristics - SDRAM

 $T_A = 0 - 70C$; $V_{DD}=3.3V + /-5\%$; $C_L = 10-30$ pF (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Impedance	R _{DSP1} ¹	$V_{O} = V_{DD}^{*}(0.5)$	12		55	Ω
Output High Voltage	V _{OH} ¹	$I_{OH} = -1 \text{ mA}$	2.4	3.25		V
Output Low Voltage	V_{OL}^{1}	$I_{OL} = 1 \text{ mA}$		0.05	0.55	V
Output High Current	I _{OH} ¹	V _{OH@MIN} = 1.0 V,	-66	-130		
Output High Current	IOH	V _{OH@MAX} = 3.135 V		-15	-33	mA
Output Low Current	l _{OL} 1	$V_{OL @MIN} = 1.95 V$,	60	145		
Odipat Low Current	IOL	$V_{OL @MAX} = 0.4 V$		59	72	mA
Rise Time	t _{r1} 1	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$	0.5	0.65	2	ns
Fall Time	t _{f1} 1	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$	0.5	0.61	2	ns
Duty Cycle	d _{t1} ¹	$V_{T} = 1.5 \text{ V}$	45	46	55	%
Jitter	t _{icyc-cyc} 1	$V_T = 1.5 \text{ V} 3V66$		172	200	ps

¹Guaranteed by design, not 100% tested in production.

¹Guaranteed by design, not 100% tested in production.
² I_{OWT} can be varied and is selectable thru the MULTSEL pin.



Electrical Characteristics - PCICLK

$T_A = 0 - 70C$; $V_{DD} = 3.3V + /-5\%$; $C_L = 10-30$ pF (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Frequency	F _{O1}			33		MHz
Output Impedance	R _{DSP1} ¹	$V_O = V_{DD}^*(0.5)$	12		55	Ω
Output High Voltage	V _{OH} ¹	I _{OH} = -1 mA	2.4	3.25		٧
Output Low Voltage	V_{OL}^{1}	$I_{OL} = 1 \text{ mA}$		0.05	0.55	V
Output High Current	I _{OH} ¹	$V_{OH@MIN} = 1.0 V,$	-33	-58		
Output High Current	ЮН	V _{OH@MAX} = 3.135 V		-7	-33	mA
Output Low Current	l _{OL} ¹	$V_{OL @MIN} = 1.95 V,$	30	62		
Output Low Gurrent	OL	$V_{OL @MAX} = 0.4 V$		23	38	mA
Rise Time	t _{r1} 1	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$	0.5	1.89	2	ns
Fall Time	t _{f1} 1	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$	0.5	1.85	2	ns
Duty Cycle	d _{t1} ¹	$V_{T} = 1.5 \text{ V}$	45	51.8	55	%
Skew	t _{sk1} 1	V _T = 1.5 V		194	500	ps
Jitter, cycle to cyc	t _{icyc-cyc} 1	$V_{T} = 1.5 \text{ V}$		250	500	ps

¹Guaranteed by design, not 100% tested in production.

Electrical Characteristics - 24_48MHz, 48MHz

 $T_A = 0 - 70C$; $V_{DD}=3.3V + /-5\%$; $C_L = 10-20$ pF (unless otherwise specified)

DADAMETED	CVMDOL	CONDITIONS	MAINI	TYP	MAN	UNITS
PARAMETER	SYMBOL	CONDITIONS	MIN	IYP	MAX	UNITS
Output Frequency	F _{O1}			48		MHz
Output Impedance	R _{DSP1} ¹	$V_{O} = V_{DD}^{*}(0.5)$	20		60	Ω
Output High Voltage	V_{OH}^{-1}	I _{OH} = -1 mA	2.4	3.25		V
Output Low Voltage	V _{OL} ¹	$I_{OL} = 1 \text{ mA}$		0.05	0.4	V
		V _{OH@MIN} = 1.0 V,	-29	-58		
Output High Current	I _{OH} ¹	V _{OH@MAX} = 3.135 V		-7	-23	mA
Output Low Current	l _{OL} ¹	V _{OL @MIN} = 1.95 V	29	62		mA
		V _{OL @MAX} = 0.4 V		23	27	
48MHz Rise Time	t _{r1} 1	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$	1	1.27	2	ns
48MHz Fall Time	t _{f1} 1	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$	1	1.36	2	ns
48MHz Duty Cycle	d _{t1} ¹	V _T = 1.5 V	45	54.5	55	%
48MHz Jitter	t _{icyc-cyc} 1	V _T = 1.5 V		287	350	ps

¹Guaranteed by design, not 100% tested in production.



Electrical Characteristics - ZCLK [1:0]

 $T_A = 0 - 70C$; $V_{DD} = 3.3V + /-5\%$; $C_L = 10-30$ pF (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Frequency	F _{O1}			66.67		MHz
Output Impedance	R _{DSP1} ¹	$V_{O} = V_{DD}^{*}(0.5)$	12		55	Ω
Output High Voltage	V _{OH} ¹	I _{OH} = -1 mA	2.4	3.25		V
Output Low Voltage	V_{OL}^{1}	I _{OL} = 1 mA		0.05	0.55	٧
Output High Current	I _{OH} ¹	$V_{OH@MIN} = 1.0 V$	-33	-72		
Odipat Flight Odifierit	IOH	V _{OH@MAX} = 3.135 V		-9	-33	mA
Output Low Current	l _{OL} ¹	$V_{OL @MIN} = 1.95 V,$	30	78		
Output Low Guirent	IOL	V _{OL @MAX} = 0.4 V		29	38	mA
Rise Time	t _{r1} 1	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$	0.5	1.6	2	ns
Fall Time	t _{f1} 1	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$	0.5	1.4	2	ns
Duty Cycle	d _{t1} ¹	$V_T = 1.5 \text{ V}$	45	51.8	55	%
Skew	t _{sk1} 1	V _T = 1.5 V		24	150	ps
Jitter	t _{icyc-cyc} 1	$V_{T} = 1.5 \text{ V}$		400	500	ps

¹Guaranteed by design, not 100% tested in production.

Electrical Characteristics - AGP [1:0]

 $T_A = 0 - 70C$; $V_{DD}=3.3V + /-5\%$; $C_L = 10-30$ pF (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Frequency	F _{O1}			66.67		MHz
Output Impedance	R _{DSP1} ¹	$V_O = V_{DD}^*(0.5)$	12		55	Ω
Output High Voltage	V _{OH} ¹	$I_{OH} = -1 \text{ mA}$	2.4	3.25		٧
Output Low Voltage	V _{OL} ¹	$I_{OL} = 1 \text{ mA}$		0.05	0.55	٧
Output High Current	I _{OH} ¹	$V_{OH@MIN} = 1.0 V$,	-33	-72		
Output High Current	ЧОН	V _{OH@MAX} = 3.135 V		-9	-33	mA
Output Low Current	l _{OL} ¹	$V_{OL @MIN} = 1.95 V,$	30	78		
Output Low Gurrent		$V_{OL @MAX} = 0.4 V$		29	38	mA
Output Low Current	l _{OL} ¹	$V_{OL @MAX} = 0.4 V$			38	mA
Rise Time	t _{r1} 1	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$	0.5	1.86	2	ns
Fall Time	t _{f1}	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$	0.5	1.49	2	ns
Duty Cycle	d _{t1} ¹	$V_T = 1.5 \text{ V}$	45	51	55	%
Skew	t _{sk1} 1	$V_{T} = 1.5 \text{ V}$		6	250	ps
Jitter	t _{icyc-cyc} 1	$V_T = 1.5 \text{ V} 3V66$		379	400	ps

¹Guaranteed by design, not 100% tested in production.

Electrical Characteristics - REF

 $T_A = 0 - 70C$; $V_{DD} = 3.3V + /-5\%$; $C_L = 10-20$ pF (unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Frequency	F _{O1}			14.3		MHz
Output Impedance	R _{DSP1} ¹	$V_O = V_{DD}^*(0.5)$	20		60	Ω
Output High Voltage	V _{OH} ¹	$I_{OH} = -1 \text{ mA}$	2.4	3.25		V
Output Low Voltage	V _{OL} ¹	I _{OL} = 1 mA		0.05	0.55	V
Output High Current	I _{OH} ¹	$V_{OH@MIN} = 1.0 V$,	-33	-58		
Output High Current	' ОН	V _{OH@MAX} = 3.135 V		-7	-33	mA
Output Low Current	l _{OL} ¹	$V_{OL @MIN} = 1.95 V$,	30	62		
Output Low Current	IOL	V _{OL @MAX} = 0.4 V		23	38	mA
Rise Time	t _{r1} 1	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$	1	1.4	4	ns
Fall Time	t _{f1} 1	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$	1	1.3	4	ns
Duty Cycle	d _{t1} ¹	$V_{T} = 1.5 \text{ V}$	45	54.3	55	%
Jitter	t _{icyc-cyc} 1	V _T = 1.5 V		312	1000	ps

¹Guaranteed by design, not 100% tested in production.



Shared Pin Operation - Input/Output Pins

The I/O pins designated by (input/output) serve as dual signal functions to the device. During initial power-up, they act as input pins. The logic level (voltage) that is present on these pins at this time is read and stored into a 5-bit internal data latch. At the end of Power-On reset, (see AC characteristics for timing values), the device changes the mode of operations for these pins to an output function. In this mode the pins produce the specified buffered clocks to external loads.

To program (load) the internal configuration register for these pins, a resistor is connected to either the VDD (logic 1) power supply or the GND (logic 0) voltage potential. A 10 Kilohm (10K) resistor is used to provide both the solid CMOS programming voltage needed during the power-up programming period and to provide an insignificant load on the output clock during the subsequent operating period. Figure 1 shows a means of implementing this function when

a switch or 2 pin header is used. With no jumper is installed the pin will be pulled high. With the jumper in place the pin will be pulled low. If programmability is not necessary, than only a single resistor is necessary. The programming resistors should be located close to the series termination resistor to minimize the current loop area. It is more important to locate the series termination resistor close to the driver than the programming resistor.

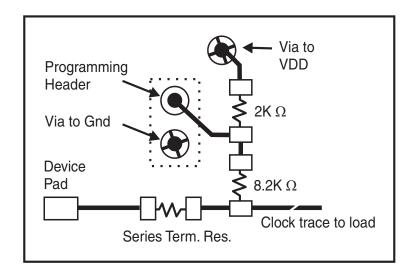
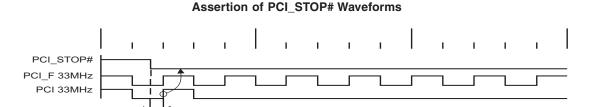


Fig. 1



PCI_STOP# - Assertion (transition from logic "1" to logic "0")

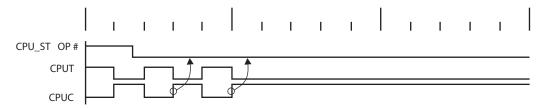
The impact of asserting the PCI_STOP# signal will be the following. All PCI and stoppable PCI_F clocks will latch low in their next high to low transition. The PCI_STOP# setup time tsu is 10 ns, for transitions to be recognized by the next rising edge.



CPU_STOP# - Assertion (transition from logic "1" to logic "0")

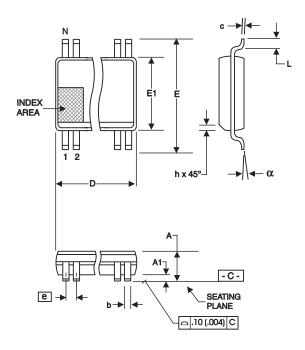
The impact of asserting the CPU_STOP# pin is all CPU outputs that are set in the I^2C configuration to be stoppable via assertion of CPU_STOP# are to be stopped after their next transition following the two CPU clock edge sampling as shown. The final state of the stopped CPU signals is CPUT=Low and CPUC=High. There is to be no change to the output drive current values. The CPUT will be driven high with a current value equal to (MULTSEL0) X (I REF), the CPUC signal will not be driven.





CPU_STOP# Functionality

CPU_STOP#	CPUT	CPUC
1	Normal	Normal
0	iref * Mult	Float



	In Millir	neters	In Inches				
SYMBOL	COMMON D	IMENSIONS	COMMON [DIMENSIONS			
	MIN	MAX	MIN	MAX			
Α	2.41	2.80	.095	.110			
A1	0.20	0.40	.008	.016			
b	0.20	0.34	.008	.0135			
С	0.13	0.25	.005	.010			
D	SEE VAR	IATIONS	SEE VAI	RIATIONS			
E	10.03	10.68	.395	.420			
E1	7.40	7.60	.291	.299			
е	0.635 I	BASIC	0.025	BASIC			
h	0.38	0.64	.015	.025			
L	0.50	1.02	.020	.040			
N	SEE VAR	IATIONS	SEE VAI	RIATIONS			
α	0°	8°	0°	8°			

VARIATIONS

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
48	15.75	16.00	.620	.630

Reference Doc.: JEDEC Publication 95, MO-118

10-0034

Ordering Information

ICS952004yFLFT



0489D-05/05/05

#Ire	Integrated Circuit Systems, Inc.
	Circuit
	Systems, Inc.

Revision History

Rev.	Issue Date	Description	Page #
D	5/5/2005	Added LF Ordering Information	19